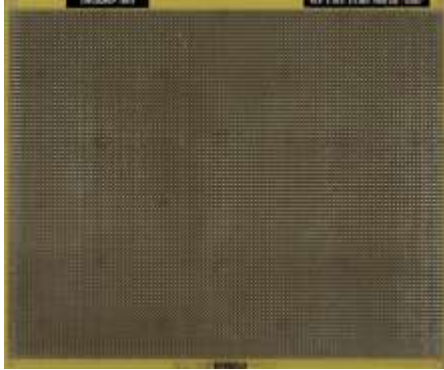


8013 Vectorbord® Circbord™



Description

- Pad-Per-Hole, Plated-thru holes
- 0.080" diameter isolated solder pad around each hole on both sides.
- Unrestricted component placement & extended area for high density applications

Specifications

Dimensions (H x W x Thick)	10.6" x 18.00" x 0.062" (269.24mm x 457.2mm x 1.57mm)
Hole Diameter	0.042" (1.067mm) Plated Thru
Grid	0.100" x 0.100" (2.54mm x 2.54mm)
Circuit Pattern	Pad per hole - both sides
Material	FR4
UL Flammability Class	94V-0
16 Pin DIP Capacity	165
Wire-Wrap Terminals	T44, T46, T49, T68
Solder Terminals	T42-1, K24C, K31C
Wire-Wrap Socket Pins	R32